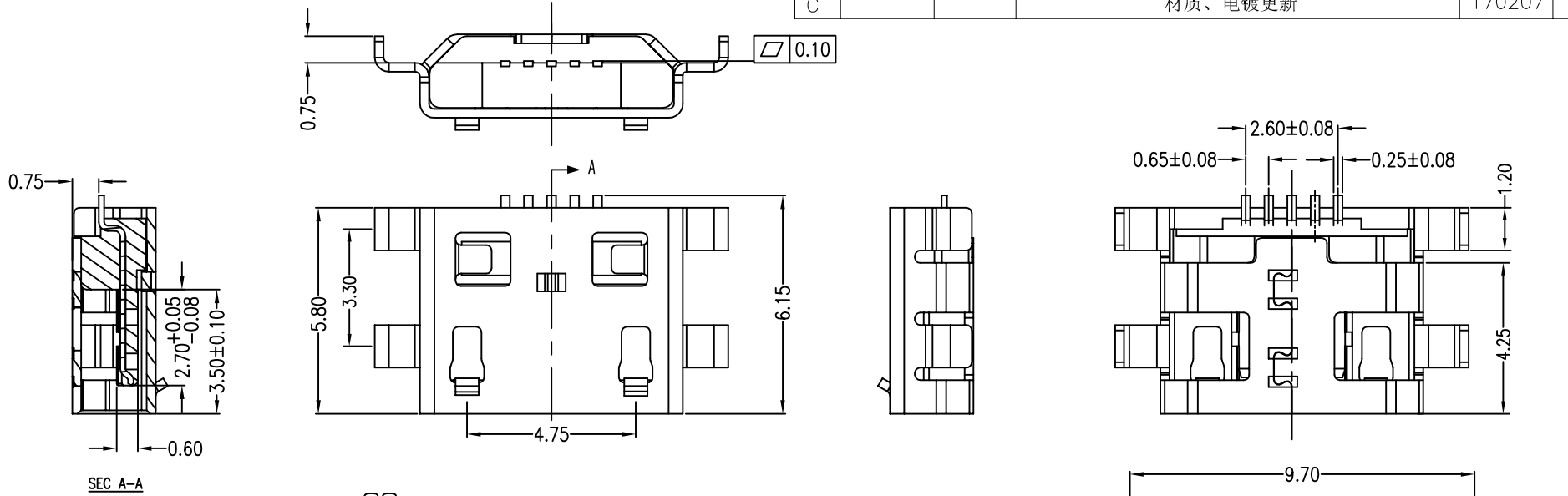


所有原料材质，生产制程，电镀必须符合RoHS要求

REV.	ECN NO.	LOCAS.	DESCRIPTION	DATE	DESIGN
A0			RELEASE TO CUSTOMER	150116	RYAN
B				161212	RYAN
C			材质、电镀更新	170207	RYAN



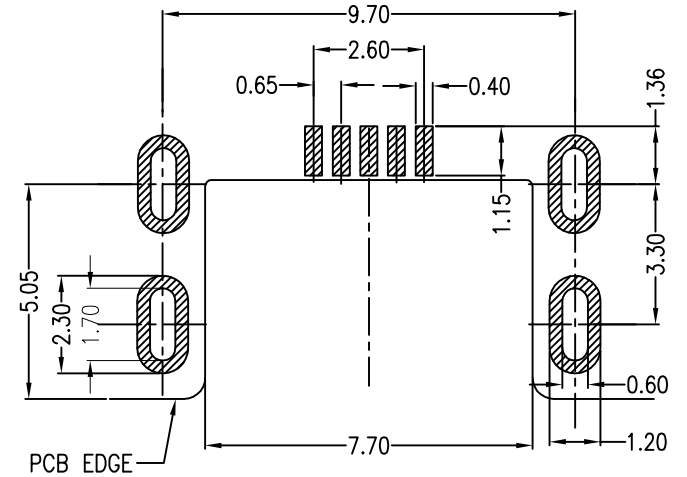
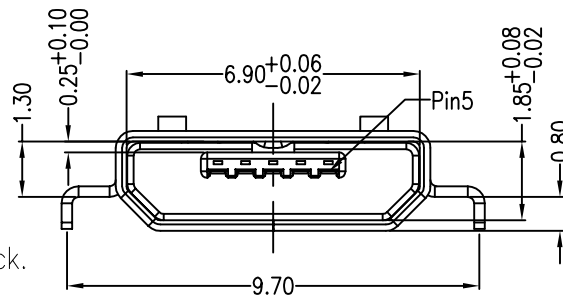
Note:

1. Material and finish:

- 1.1 Housing: High temperature thermoplastic with g.f, UL94v-0, Black.
- 1.2 Contact: copper alloy, t=0.15mm, 50u" MIN Nickel underplating over all, 0.6u" Glod Flash at contact area.
- 1.3 Shell: copper alloy, t=0.25mm. Matte TIN plated.

2. Specification:

- 2.1 Current rating: 1,5PIN 1A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C



RECOMMENDED PCB LAYOUT

DIM	TOL	DIM	TOL
X.	±0.30	X'.	±4.0°
X.X	±0.25	X.X'	±3.0°
X.XX	±0.20	X.XX'	±2.0°
X.XXX	±0.10	X.XXX'	±1.0°

THIS DRAWING CONTAINS INFORMATION THAT IS PROVIDED BY LASTAR TECHNOLOGY AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

DRAW NO.		DATE		DRAW NAME:	
322-C5E-05W3		170207		MICRO USB 5PIN沉板0.8 四脚全插 平口	
DESIGN		170207		P/N NO. USB-322-C5E-05W3	
CHECK		170207		SHORT CODE	
APPROVED		170207		MODEL W3	
HUYX		170207		REV. C	
UNIT: mm		SHEET: N/A		SCALE N/A	

LASTAR

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